Tyrone Camarero Specifications

Camarero DS300TTR-224R

Key features

Four hot-pluggable systems (nodes) in a 2U form factor. Each node supports the following:

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600v4/v3 family •
- Intel[®] C612 chipset •
- Up to 1TB ECC 3DS LRDIMM, up to DDR4- 2400MHz ; 8x DIMM slots •
- 1x PCI-E 3.0 x16 (LP) slot •
- Intel® i350 Dual port GbE LAN ٠
- 6x 2.5" Hot-swap SATA3 drive bays
- 1600W Redundant Power Supplies Titanium Level
- 2x SATA DOM



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Processor/Cache		Front Panel	
Processor	Dual socket R3 (LGA 2011) supports Intel [®] Xeon [®] processor E5-2600v4/v3 family	LED Indicators	Power status LED, HDD activity LED, 2x Network activity LEDs, Universal Information (UID) LED
		Buttons	Power On/Off button, System Reset buttor UID button
Chipset		Drive Bays	
Chipset	Intel® C612 chipset	HDD bays	6x 2.5" Hot-swap SATA3 drive bays
System Memory		Power Supply	
Memory Capacity	8x 288-pin DDR4 DIMM slots, Up to 1TB ECC 3DS LRDIMM, 256 ECC RDIMM	1600W Redundant Power Supplies Titanium Level	
Expansion Slots		Cooling System	
	1x PCI-E 3.0 (x16) Low-profile slot	4x 8cm heavy dut	ty fans with PWM fan speed control
Integrated On-Board		Form Factor	
SATA	SATA3 (6Gbps) with RAID 0, 1, 5, 10	Form Factor	2U Rackmount
LAN	2x RJ45 Gigabit Ethernet LAN ports, 1x RJ45 Dedicated IPMI LAN port	Width: Height:	17.25"(438mm), 3.47" (88mm), 28.5" (724mm)
Add-on Options		Depth:	28.5" (724mm)
Raid	Optional	Email : info@tyronesystems.com	
Optical Drive	None	For more/current product information, visit www.tyronesystems.com	

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